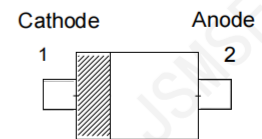


FEATURES

- Plastic SMD package
- Low leakage current: typ. 3 pA
- Switching time: typ. 0.8 μ s
- Continuous reverse voltage: max. 75 V



APPLICATION

- Low-leakage current applications in surface mounted circuits.

SOD-323

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|------------------|-------------------------------------|---|------|------|------------------|
| Per diode | | | | | |
| V_{RRM} | repetitive peak reverse voltage | | — | 85 | V |
| V_R | continuous reverse voltage | | — | 75 | V |
| I_F | continuous forward current | single diode loaded; note 1; see Fig.2 | — | 160 | mA |
| | | double diode loaded; note 1; see Fig.2 | — | 140 | mA |
| I_{FRM} | repetitive peak forward current | | — | 500 | mA |
| I_{FSM} | non-repetitive peak forward current | square wave; $T_j = 25^\circ\text{C}$ prior to surge; see Fig.4 | — | 4 | A |
| | | $t_p = 1 \mu\text{s}$ | | 1 | A |
| | | $t_p = 1 \text{ ms}$ | | 0.5 | A |
| | | $t_p = 1 \text{ s}$ | | — | — |
| P_{tot} | total power dissipation | $T_{amb} = 25^\circ\text{C}$; note 1 | — | 250 | mW |
| T_{stg} | storage temperature | | −65 | +150 | $^\circ\text{C}$ |
| T_j | junction temperature | | — | 150 | $^\circ\text{C}$ |

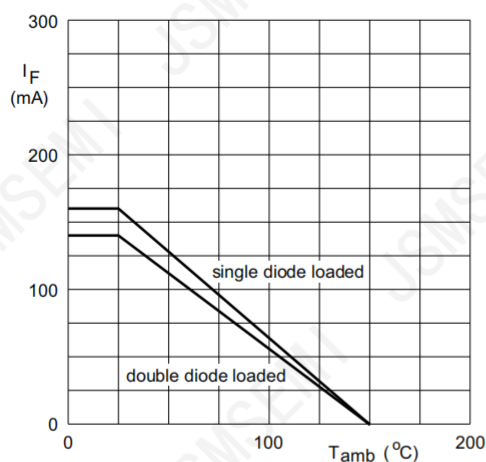
ELECTRICAL CHARACTERISTICS $T_j = 25^\circ\text{C}$ unless otherwise specified.

| SYMBOL | PARAMETER | CONDITIONS | TYP. | MAX. | UNIT |
|------------------|-----------------------|---|--------|------|---------------|
| Per diode | | | | | |
| V_F | forward voltage | see Fig.3 | — | 900 | mV |
| | | $I_F = 1 \text{ mA}$ | — | 1000 | mV |
| | | $I_F = 10 \text{ mA}$ | — | 1100 | mV |
| | | $I_F = 50 \text{ mA}$ | — | 1250 | mV |
| I_R | reverse current | see Fig.5 | 0.0033 | 5 | nA |
| | | $V_R = 75 \text{ V}$ | | 80 | A |
| C_d | diode capacitance | $f = 1 \text{ MHz}$; $V_R = 0$; see Fig.6 | 2 | — | pF |
| t_{rr} | reverse recovery time | when switched from $I_F = 10 \text{ mA}$ to $I_R = 10 \text{ mA}$; $R_L = 100 \Omega$; measured at $I_R = 1 \text{ mA}$; see Fig.7 | 0.8 | 3 | μs |

Note

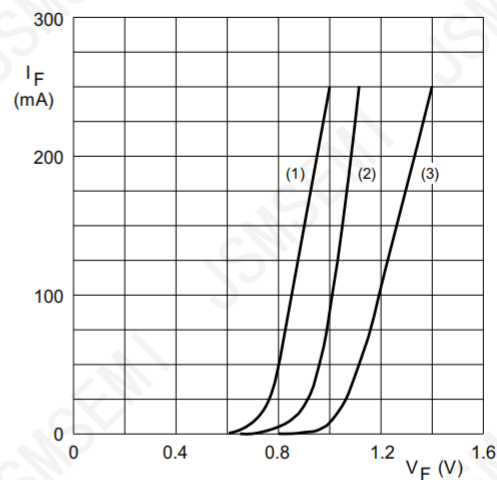
1. Device mounted on a FR4 printed-circuit board.

Typical Characteristics



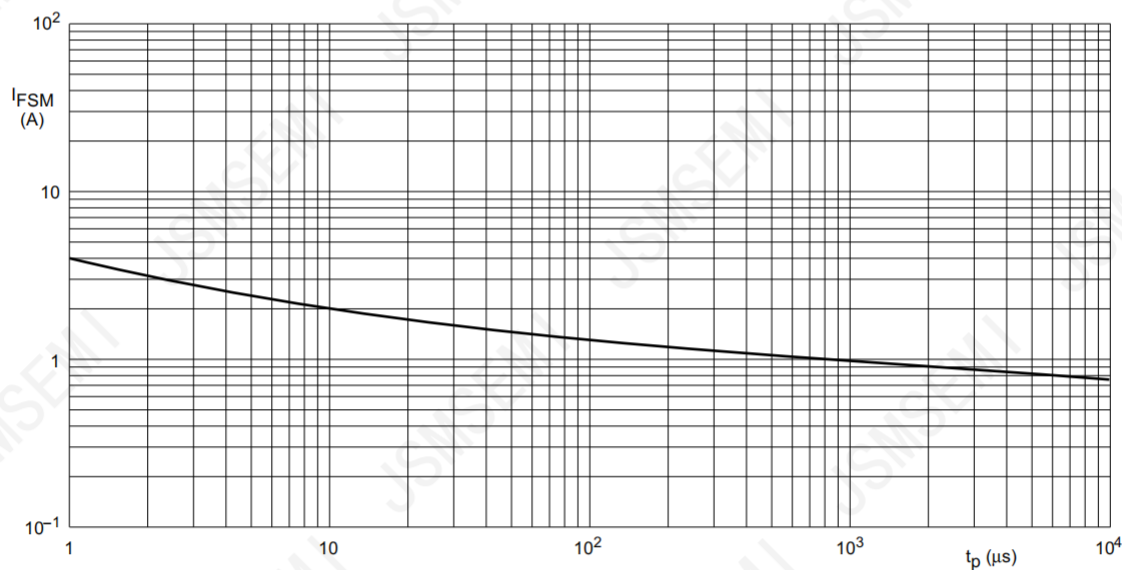
Device mounted on a FR4 printed-circuit board.

Fig.2 Maximum permissible continuous forward current as a function of ambient temperature.



- (1) T_J = 150 °C; typical values.
- (2) T_J = 25 °C; typical values.
- (3) T_J = 25 °C; maximum values.

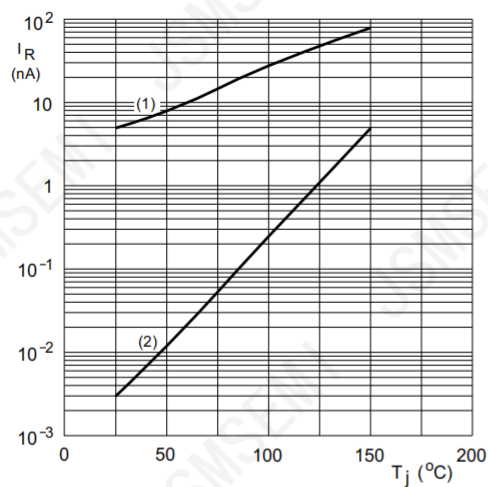
Fig.3 Forward current as a function of forward voltage; per diode.



Based on square wave currents; T_J = 25 °C prior to surge.

Fig.4 Maximum permissible non-repetitive peak forward current as a function of pulse duration per diode.

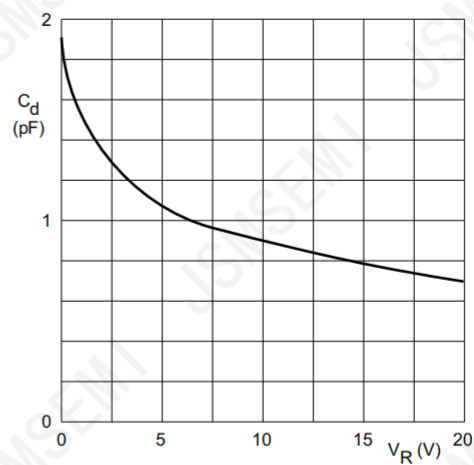
Typical Characteristics



$V_R = 75 \text{ V}$.

- (1) Maximum values.
- (2) Typical values.

Fig.5 Reverse current as a function of junction temperature; per diode.



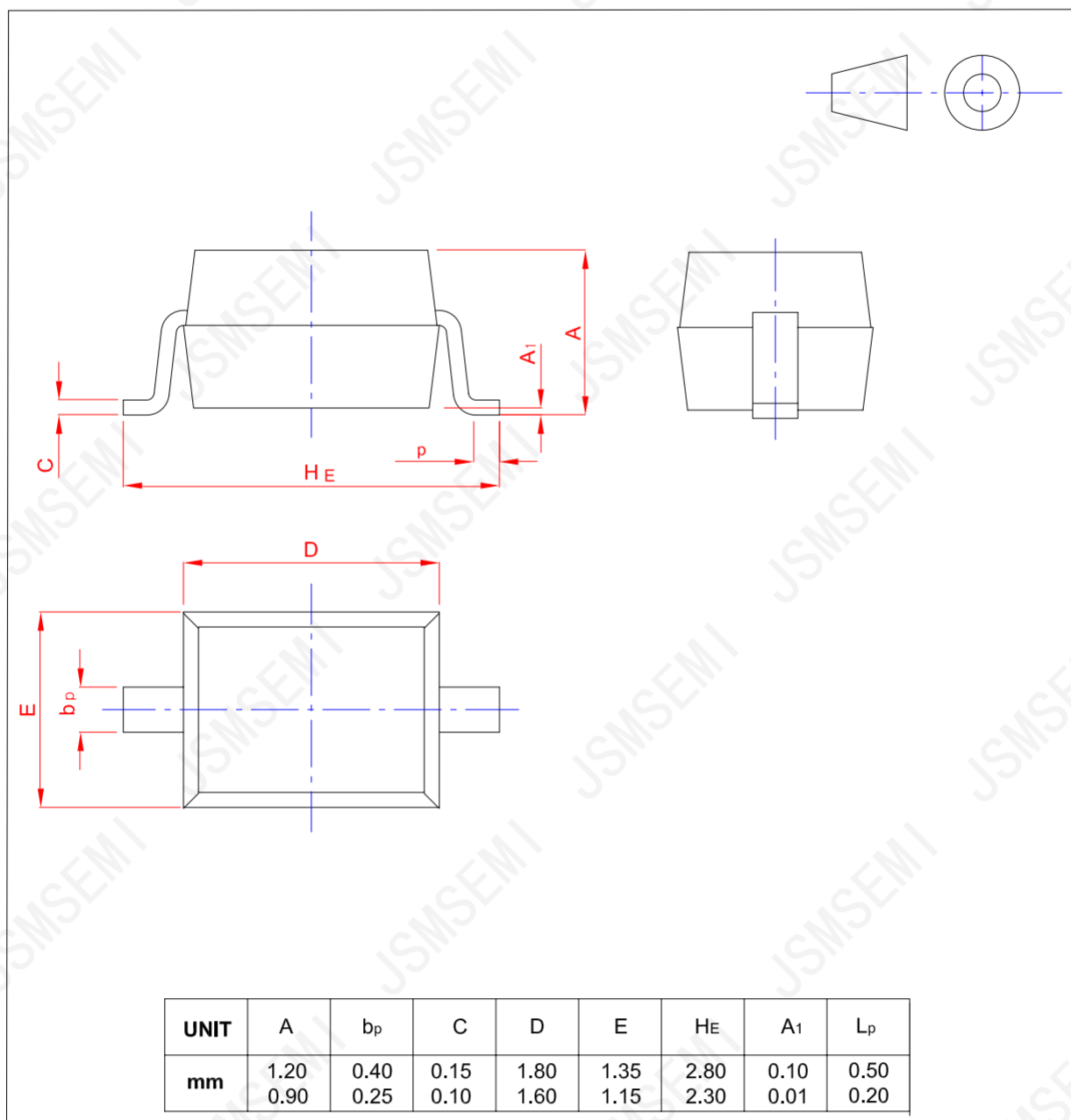
$f = 1 \text{ MHz}$; $T_J = 25 \text{ }^{\circ}\text{C}$.

Fig.6 Diode capacitance as a function of reverse voltage; per diode; typical values.

PACKAGE OUTLINE

Plastic surface mounted package; 2 leads

SOD-323



Revision History

| Rev. | Change | Date |
|------|-----------------|-----------|
| V1.0 | Initial version | 2/23/2024 |
| | | |

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